

Customer Notification

(CN Tracking Number: EE-QR-221212-01)
Version 1.0

Customer:	All Customers		
Renesas Product Type:	All products, including legacy Intersil, IDT, Dialog and Renesas except "custom-labeled" products.		
Description of Change:	Renesas Electronics will update and streamline the standard interior labels in shipments for all products in conjunction with our systems integration plan. Kindly refer to Appendix A to D for comparison of the current and new standard labels.		
Reason for Change:	To integrate company-wide standard labels through the integration of SCM systems, including logistic systems.		
Identification:	Please refer to Appendix A to D for different legacies		
Schedules:	Please refer to Appendix A to D for different implementation schedules depending on legacy		
Anticipated Impact:	Fit, Form, Function:	None	
	Quality & Reliability:	None	
	Environmental compliance:	None	
Document no.	EEQC-PCN-CR-22-0237		
Internal Reference:	PA220009		

INITIATOR	TITLE	E-mail	PHONE No.
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Düsseldorf, 15 December 2022

Details of Change:

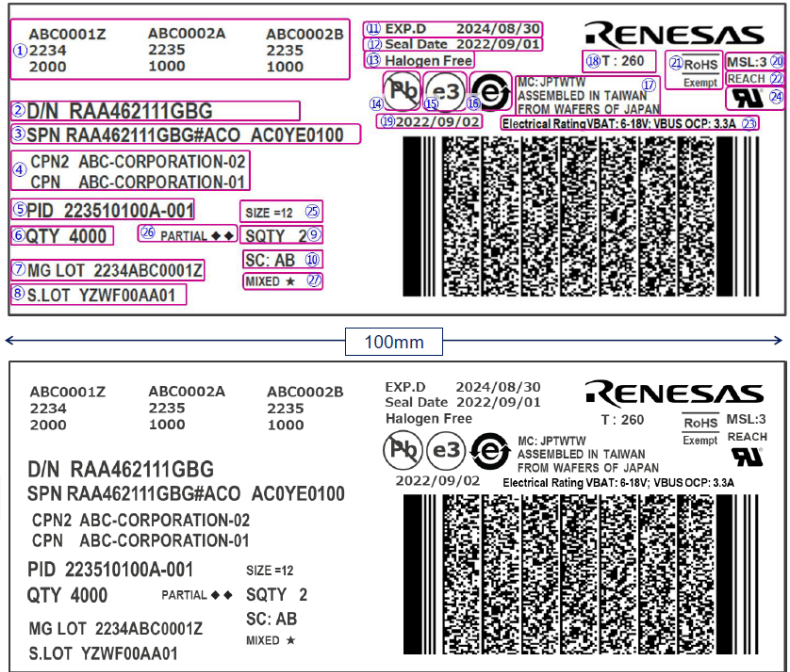
Appendix A: LEGACY INTERSIL Products
 Effective Date: 1. Aug. 2023

Product Identification: The new standard label after the change is as follows:

Label Display Items / One Renesas Standard Label

Table 3 : Label Display Item

Label Display Item
① Lot Combine Information
② D/N (Device Name)
③ SPN (SAP Parts Name)
④ CPN / CPN2 (Customer Parts No.)
⑤ PID (Pack ID)
⑥ QTY
⑦ MG LOT (Manufacturing Lot No.)
⑧ S.Lot (Shipping Batch Lot)
⑨ SQTY (Wafers Q'ty)
⑩ OSAT Code
⑪ Expiry Date
⑫ Seal Date
⑬ Halogen Free
⑭ Pb-Free Logo Mark
⑮ Pb-Free with Detail Rank Information
⑯ China RoHS (Logo Mark or "Blank")
⑰ Country of Origin
⑱ PCB On Board Reflow Rank (Peak Temp)
⑲ Labeling Date
⑳ Condition after opening (MSL Rank)
㉑ RoHS Exempt (RoHS or RoHS Exempt)
㉒ REACH Certified (REACH or "Blank")
㉓ UL Certified
㉔ UL Rank
㉕ Wafer Size
㉖ Partial Lot Sign
㉗ Mix Lot Sign



Comparison before and after change for legacy INTERSIL products:

Gap Points Current and New / Ex-ISL

For Finished Goods

For Wafer Sales

For Wafer Sales

Gap Points

- Added Items
 - PID (Traceability Control)
 - S.LOT (Traceability Control) For Renesas Internal Use
 - Add RoHS / RoHS Exempt (Display RoHS or RoHS Exempt)
 - Add China RoHS (Display China RoHS Certified)
- Design Change Items
 - SPN (Orderable Parts No.)
 - CPN/CPN2 (Customer Parts No.)
 - Lot Combine Information
 - Country of Origin (Manufacturing Country Info.)
 - PCB On Board Reflow Rank (Peak Temperature)
 - MG LOT (Manufacturing Lot No.)

For additional information regarding this notice, please contact:

For additional information regarding this notice, please contact your regional change coordinator (below)			
Americas: PCN-US@Renesas.COM	Europe: PCN-EU@Renesas.COM	Japan: PCN-JP@Renesas.COM	Asia Pac: PCN-APAC@Renesas.COM

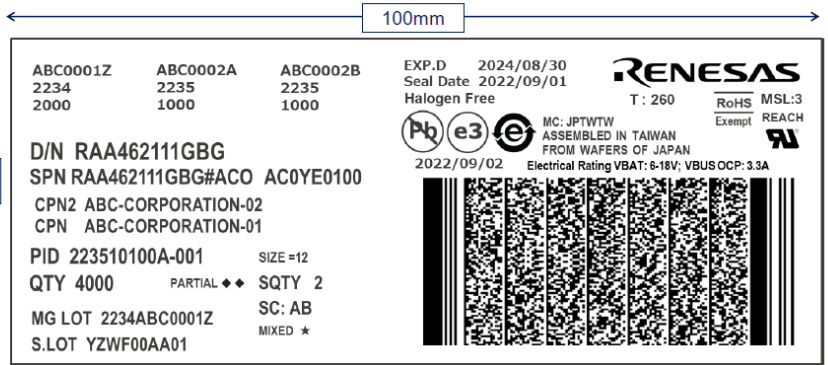
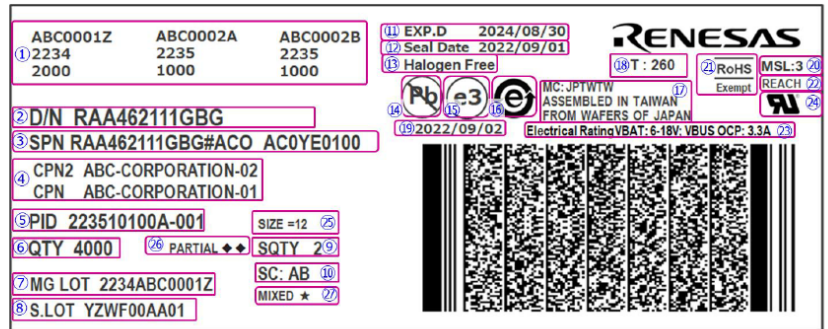
Appendix B: LEGACY IDT Products
 Effective Date: 1. Aug. 2023

Product Identification: The new standard label after the change is as follows:

Label Display Items / One Renesas Standard Label

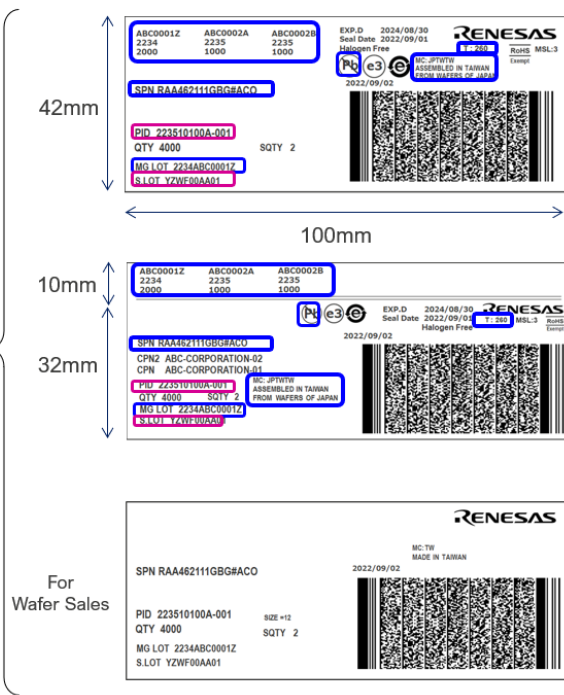
Table 3 : Label Display Item

Label Display Item
① Lot Combine Information
② D/N (Device Name)
③ SPN (SAP Parts Name)
④ CPN / CPN2 (Customer Parts No.)
⑤ PID (Pack ID)
⑥ QTY
⑦ MG LOT (Manufacturing Lot No.)
⑧ S.Lot (Shipping Batch Lot)
⑨ SQTY (Wafers Q'ty)
⑩ OSAT Code
⑪ Expiry Date
⑫ Seal Date
⑬ Halogen Free
⑭ Pb-Free Logo Mark
⑮ Pb-Free with Detail Rank Information
⑯ China RoHS (Logo Mark or "Blank")
⑰ Country of Origin
⑱ PCB On Board Reflow Rank (Peak Temp)
⑲ Labeling Date
⑳ Condition after opening (MSL Rank)
㉑ RoHS Exempt (RoHS or RoHS Exempt)
㉒ REACH Certified (REACH or "Blank")
㉓ UL Certified
㉔ UL Rank
㉕ Wafer Size
㉖ Partial Lot Sign
㉗ Mix Lot Sign



Comparison before and after change for legacy IDT products:

Gap Points Current and New / Ex-IDT



- Gap Points**
- Added Items
 - PID (Traceability Control)
 - S.LOT (Traceability Control) For Renesas Internal Use
 - Design Change Items
 - SPN (Orderable Parts No.)
 - Lot Combine Information
 - MG LOT (Manufacturing Lot No.)
 - Pb-Free's Logo Mark
 - Country of Origin (Manufacturing Country Info.)
 - PCB On Board Reflow Rank (Peak Temperature)

For additional information regarding this notice, please contact: IDT-PCN@lm.renesas.com

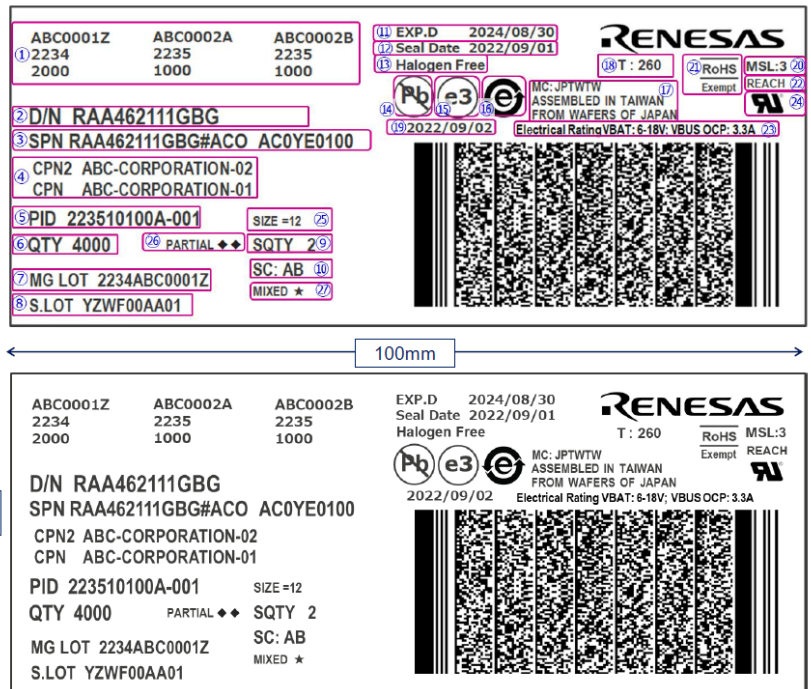
Appendix C: LEGACY DIALOG Products
Effective Date: 1. Aug. 2023

Product Identification: The new standard label after the change is as follows:

Label Display Items / One Renesas Standard Label

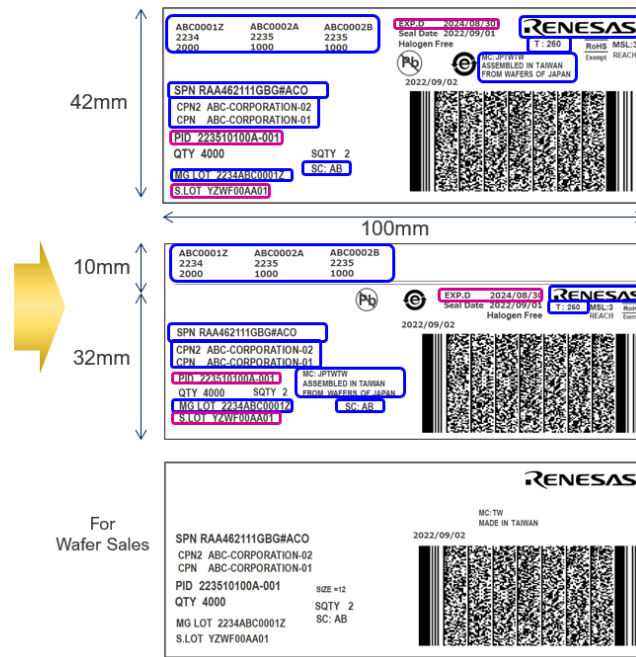
Table 3 : Label Display Item

Label Display Item
① Lot Combine Information
② D/N (Device Name)
③ SPN (SAP Parts Name)
④ CPN / CPN2 (Customer Parts No.)
⑤ PID (Pack ID)
⑥ QTY
⑦ MG LOT (Manufacturing Lot No.)
⑧ S.Lot (Shipping Batch Lot)
⑨ SQTY (Wafers Q'ty)
⑩ OSAT Code
⑪ Expiry Date
⑫ Seal Date
⑬ Halogen Free
⑭ Pb-Free Logo Mark
⑮ Pb-Free with Detail Rank Information
⑯ China RoHS (Logo Mark or "Blank")
⑰ Country of Origin
⑱ PCB On Board Reflow Rank (Peak Temp)
⑲ Labeling Date
⑳ Condition after opening (MSL Rank)
㉑ RoHS Exempt (RoHS or RoHS Exempt)
㉒ REACH Certified (REACH or "Blank")
㉓ UL Certified
㉔ UL Rank
㉕ Wafer Size
㉖ Partial Lot Sign
㉗ Mix Lot Sign



Comparison before and after change for legacy DIALOG products:

Gap Points Current and New / Ex-DLG



- Gap Points**
- Added Items
 - PID (Traceability Control)
 - EXP. Date (Traceability Control) For Renesas Internal Use
 - S.LOT (Traceability Control) For Renesas Internal Use
 - Design Change Items
 - Renesas Logo Mark
 - SPN (Orderable Parts No.)
 - CPN/CPN2 (Customer Parts No.)
 - MG LOT (Manufacturing Lot No.)
 - Lot Combine Information
 - Country of Origin (Manufacturing Country Info.)
 - PCB On Board Reflow Rank (Peak Temperature)
 - SC (Test Supplier Code)

For additional information regarding this notice, please contact your Renesas Sales Representative

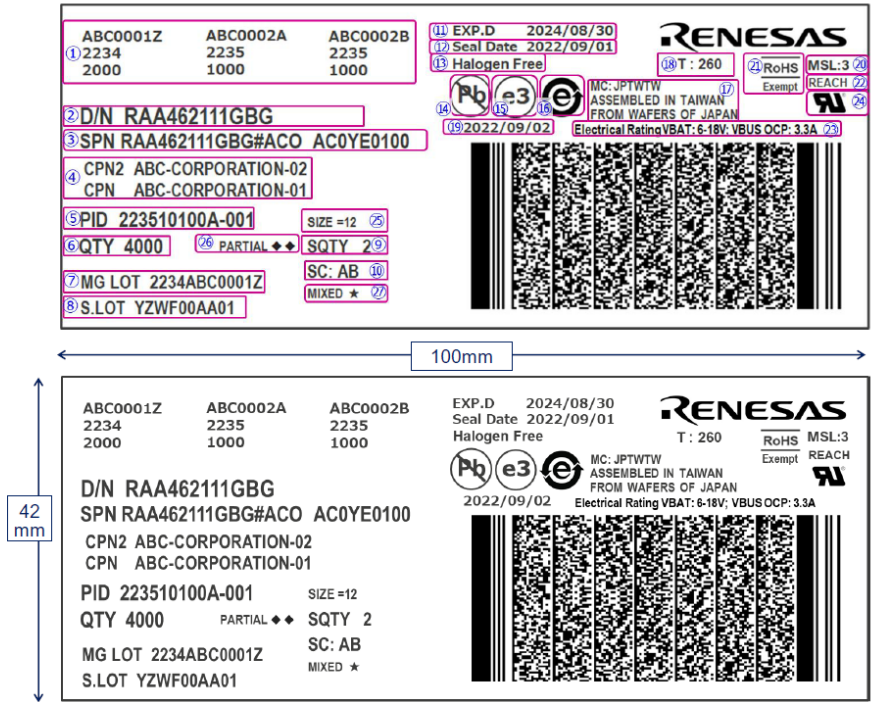
Appendix D: LEGACY RENESAS Products
 Effective Date: 1. Apr. 2024

Product Identification: The new standard label after the change is as follows:

Label Display Items / One Renesas Standard Label

Table 3 : Label Display Item

Label Display Item
① Lot Combine Information
② D/N (Device Name)
③ SPN (SAP Parts Name)
④ CPN / CPN2 (Customer Parts No.)
⑤ PID (Pack ID)
⑥ QTY
⑦ MG LOT (Manufacturing Lot No.)
⑧ S.Lot (Shipping Batch Lot)
⑨ SQTY (Wafers Q'ty)
⑩ OSAT Code
⑪ Expiry Date
⑫ Seal Date
⑬ Halogen Free
⑭ Pb-Free Logo Mark
⑮ Pb-Free with Detail Rank Information
⑯ China RoHS (Logo Mark or "Blank")
⑰ Country of Origin
⑱ PCB On Board Reflow Rank (Peak Temp)
⑲ Labeling Date
⑳ Condition after opening (MSL Rank)
㉑ RoHS Exempt (RoHS or RoHS Exempt)
㉒ REACH Certified (REACH or "Blank")
㉓ UL Certified
㉔ UL Rank
㉕ Wafer Size
㉖ Partial Lot Sign
㉗ Mix Lot Sign



Comparison before and after change for legacy RENESAS products:

Gap Points Current and New / Renesas Japan (REL)



Gap Points

- Design Change Items
- Pb-Free's Logo Mark
- PCB On Board Reflow Rank (Peak Temperature)
- Customer Parts No. (Display Name Change) PN/PN2 => CPN/CPN2
- MG LOT (Display Name Change) T/C => MG LOT
- PCN (Deleted Item)

For additional information regarding this notice, please contact your Renesas Sales Representative